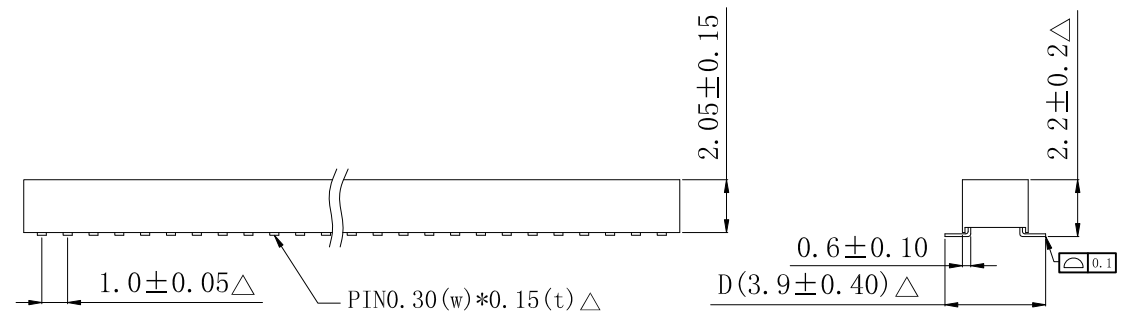


P. C. B SMT Layout

### Specifications

Current Rating	:0.8 Amp
Insulator Resistance	:900 Megohms Min.
Contact Resistance	:20 m ohms max.
Dielectric Withstanding	:AC 500 V
Operating Temperature	:-40 °C ~ +105°C
Soldering Temperature	:260°C for 3~5sec Max.
Contact Material	:Phosphor Bronze
Insulator Material	:High Temperature Thermoplastic. UL 94V-0
Standard	:LCP
Finish	:Gold Plated
Standard	:Gold Flash all over



Series	Connector Type	Contact Plating	Material	Pin Length mm	Number of Contacts
F801	X	X	X	DXXX	-XX
(Female Header Dual Row)	M: SMT Type	G: Gold Flash T: Tin Plated	C: LCP (Standard: C)	M-D D039	(04 TO 80 Contacts)
F801 (1.00 H: 2.05 W: 2.55)		A: 10U" Gold B: 15U" Gold C: 20U" Gold			
		©Duplex Plating D: Gold Flash/Tin (Standard: G)			



<b>DESCRIPTION(内容):</b> 1.00mm Female Header H:2.05 SMT LCP (RoHS)	<b>DRAWN(製圖):</b> 黄炳秋	<b>GENERAL TOLERANCE:(公差)</b> X. ±0.30 X. ° ±5.0° .X ±0.20 .X ° ±3.0° .XX ±0.15 .XX ° ±1.0°	<b>REV:</b> A/2	<b>REV</b> 1	<b>DESCRIPTION</b> △此符號表示重點管控尺寸	<b>DATE</b> 2014.12.10	
	<b>CHECKED(確認):</b> 黄炳秋		<b>UNIT:</b> mm				<b>2</b>
	<b>PART NO:(料號)</b> F801-MGC-D039-XX	<b>APPROVAL(核准):</b> 邓文广	<b>SCALE(比例):</b> XX:XX	<b>SIZE:</b> A4	<b>3</b>		
	<b>DWG NO(圖號):</b>			<b>SHEET:</b> 1/1	<b>4</b>		